**Product data sheet** 

## 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 30 V
- Low forward voltage
- High power capability due to clip-bond technology
- AEC-Q101 qualified
- Small and flat lead SMD plastic package
- Capable for reflow and wave soldering

### 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- · Reverse polarity protection
- Low power consumption applications

### 4. Quick reference data

Table 1. Quick reference data

| Symbol             | Parameter               | Conditions  |     | Min | Тур | Max | Unit |
|--------------------|-------------------------|---|-----|-----|-----|-----|------|
| I <sub>F(AV)</sub> | average forward current | $\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 120$ °C; square wave | [1] | -   | -   | 1   | А    |
|                    |                         | $\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 140$ °C; square wave  |     | -   | -   | 1   | А    |
| $V_R$              | reverse voltage         | T <sub>j</sub> = 25 °C  |     | -   | -   | 30  | V    |
| V <sub>F</sub>     | forward voltage         | I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C                  |     | -   | 405 | 450 | mV   |
| I <sub>R</sub>     | reverse current         | V <sub>R</sub> = 30 V; T <sub>j</sub> = 25 °C                 |     | -   | 15  | 50  | μΑ   |

[1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.



# 5. Pinning information

### **Table 2. Pinning information**

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--------------------|----------------|
| 1   | K      | cathode[1]  |                    | к <b>_}</b> А  |
| 2   | А      | anode       | 1 2 CFP5 (SOD128)  | sym001         |

<sup>[1]</sup> The marking bar indicates the cathode.

# 6. Ordering information

### **Table 3. Ordering information**

| Type number | Package |  |         |  |  |  |
|-------------|---------|--|---------|--|--|--|
|             | Name    | Description  | Version |  |  |  |
| PMEG3010BEP | CFP5    | plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body | SOD128  |  |  |  |

# 7. Marking

### **Table 4. Marking codes**

| Type number | Marking code |
|-------------|--------------|
| PMEG3010BEP | A2           |

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol             | Parameter                           | Conditions  |     | Min | Max  | Unit |
|--------------------|-------------------------------------|---|-----|-----|------|------|
| V <sub>R</sub>     | reverse voltage                     | T <sub>j</sub> = 25 °C  |     | -   | 30   | V    |
| I <sub>F(AV)</sub> | average forward current             | $\delta$ = 0.5; f = 20 kHz; $T_{amb} \le 120$ °C; square wave | [1] | -   | 1    | А    |
|                    |                                     | $\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 140$ °C; square wave  |     | -   | 1    | А    |
| I <sub>FSM</sub>   | non-repetitive peak forward current | $t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C              |     | -   | 50   | А    |
| P <sub>tot</sub>   | total power dissipation             | T <sub>amb</sub> ≤ 25 °C                                      | [2] | -   | 625  | mW   |
|                    |                                     |   | [3] | -   | 1.05 | W    |
|                    |                                     |   | [1] | -   | 2.1  | W    |
| Tj                 | junction temperature                |   |     | -   | 150  | °C   |
| T <sub>amb</sub>   | ambient temperature                 |   |     | -55 | 150  | °C   |
| T <sub>stg</sub>   | storage temperature                 |   |     | -65 | 150  | °C   |

- [1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

| Symbol                | Parameter  | Conditions |            | Min | Тур | Max | Unit |
|-----------------------|--|------------|------------|-----|-----|-----|------|
| R <sub>th(j-a)</sub>  | thermal resistance                               |            | [1] [2]    | -   | -   | 200 | K/W  |
|                       | from junction to ambient                         |            | [3] [2]    | -   | -   | 120 | K/W  |
|                       |  |            | [4] [2]    | -   | -   | 60  | K/W  |
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point |            | <u>[5]</u> | -   | -   | 12  | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

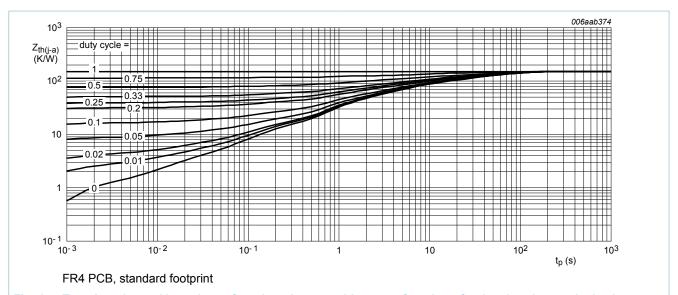


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

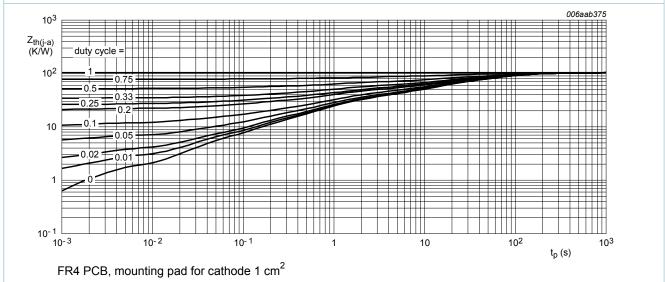
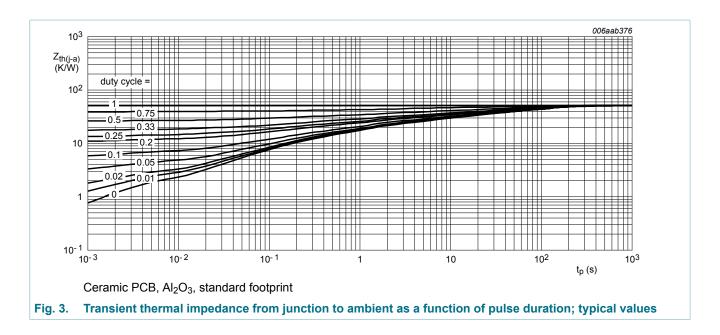


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



## 10. Characteristics

#### **Table 7. Characteristics**

| Symbol         | Parameter         | Conditions  | Min | Тур | Max | Unit |
|----------------|-------------------|---|-----|-----|-----|------|
| V <sub>F</sub> | forward voltage   | $I_F = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}$                    | -   | 315 | 360 | mV   |
|                |                   | $I_F = 0.7 \text{ A}; T_j = 25 ^{\circ}\text{C}$                    | -   | 390 | 430 | mV   |
|                |                   | I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C                        | -   | 405 | 450 | mV   |
| I <sub>R</sub> | reverse current   | V <sub>R</sub> = 5 V; T <sub>j</sub> = 25 °C                        | -   | 2   | -   | μA   |
|                |                   | $V_R = 10 \text{ V}; T_j = 25 ^{\circ}\text{C}$                     | -   | 3   | -   | μA   |
|                |                   | $V_R = 30 \text{ V}; T_j = 25 ^{\circ}\text{C}$                     | -   | 15  | 50  | μA   |
| C <sub>d</sub> | diode capacitance | $V_R = 1 \text{ V; } f = 1 \text{ MHz; } T_j = 25 ^{\circ}\text{C}$ | -   | 170 | -   | pF   |
|                |                   | $V_R = 10 \text{ V}; f = 1 \text{ MHz}; T_j = 25 ^{\circ}\text{C}$  | -   | 60  | -   | pF   |

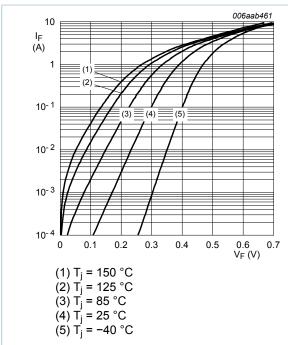


Fig. 4. Forward current as a function of forward voltage; typical values

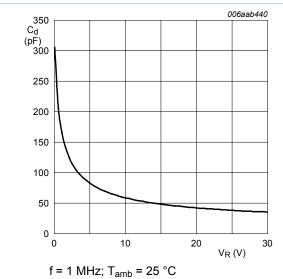


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

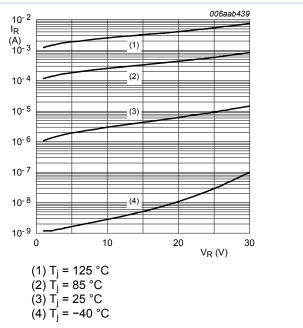
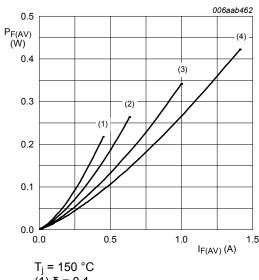


Fig. 5. Reverse current as a function of reverse voltage; typical values



 $T_j = 150 \,^{\circ}\text{C}$   $(1) \, \delta = 0.1$   $(2) \, \delta = 0.2$   $(3) \, \delta = 0.5$  $(4) \, \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

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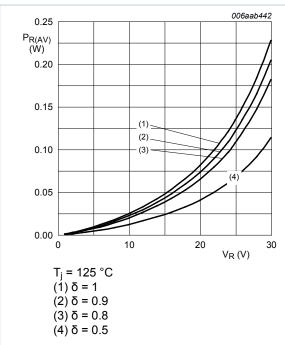
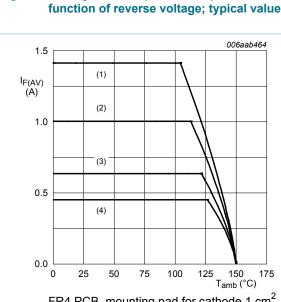


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

T<sub>i</sub> = 150 °C

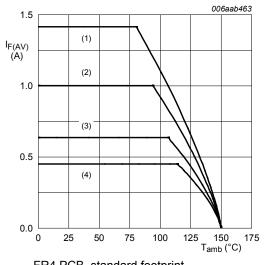
 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



FR4 PCB, standard footprint

 $T_i = 150 \,^{\circ}C$ 

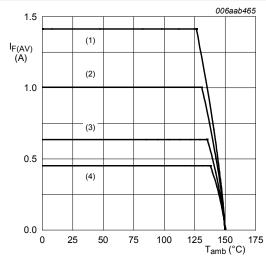
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Average forward current as a function of Fig. 9. ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 150 °C

 $(1) \delta = 1; DC$ 

(2)  $\delta$  = 0.5; f = 20 kHz

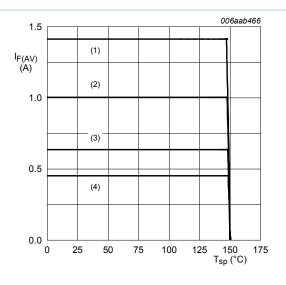
(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values

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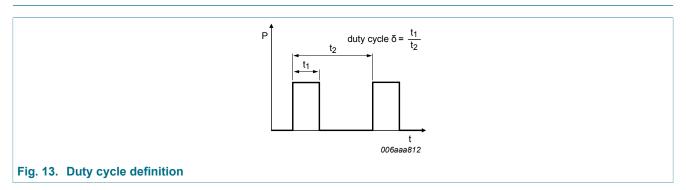
#### 1 A low Vf MEGA Schottky barrier rectifier



 $T_j = 150 \,^{\circ}\text{C}$ (1)  $\delta = 1$ ; DC (2)  $\delta = 0.5$ ;  $f = 20 \,\text{kHz}$ (3)  $\delta = 0.2$ ;  $f = 20 \,\text{kHz}$ (4)  $\delta = 0.1$ ;  $f = 20 \,\text{kHz}$ 

Fig. 12. Average forward current as a function of solder point temperature; typical values

### 11. Test information

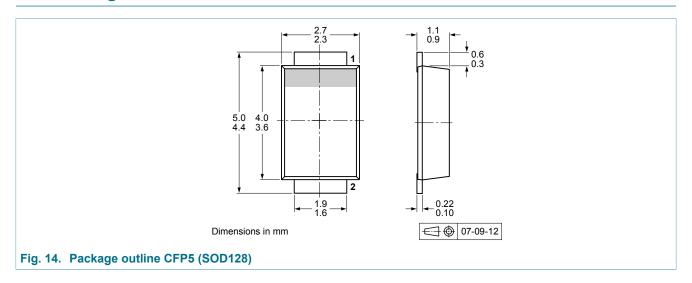


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

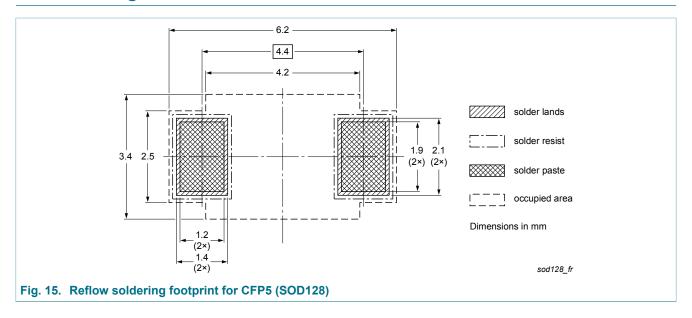
#### **Quality information**

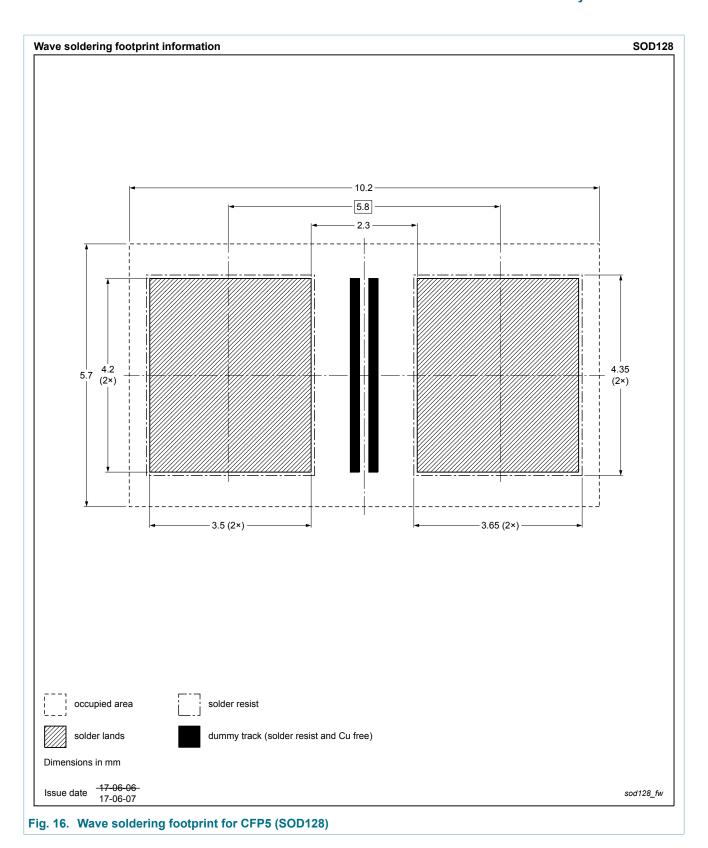
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline



# 13. Soldering





# 14. Revision history

#### Table 8. Revision history

| Table of Revision metery |   |                    |               |                   |  |  |  |  |
|--------------------------|---|--------------------|---------------|-------------------|--|--|--|--|
| Data sheet ID            | Release date  | Data sheet status  | Change notice | Supersedes        |  |  |  |  |
| PMEG3010BEP v.2          | 20180328  | Product data sheet | -             | PMEG3010BEP<br>_1 |  |  |  |  |
| Modifications:           | <ul> <li>Features and benefits: Capable for reflow and wave soldering added</li> <li>Soldering: Wave soldering footprint added</li> </ul> |                    |               |                   |  |  |  |  |
| PMEG3010BEP<br>_1        | 20090420  | Product data sheet | -             | -                 |  |  |  |  |

# 15. Legal information

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| Document status [1][2]               | Product status [3] | Definition  |
|--------------------------------------|--------------------|---|
| Objective<br>[short] data<br>sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary<br>[short] data<br>sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product<br>[short] data<br>sheet     | Production         | This document contains the product specification.                                     |

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# PMEG3010BEP

### 1 A low Vf MEGA Schottky barrier rectifier

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